506188015 08/04/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6234754

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DONG YOUNG WON	12/27/2017
HYUN JAI LIM	12/27/2017
KYUNG SU KIM	12/27/2017

RECEIVING PARTY DATA

Name:	SKCKOLON PI INC.
Street Address:	27, GODEUNG 1-GIL
Internal Address:	IWOL-MYEON, JINCHEON-GUN
City:	CHUNGCHEONGBUK-DO
State/Country:	KOREA, REPUBLIC OF

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16944029

CORRESPONDENCE DATA

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Address Line 1: SEED IP LAW GROUP LLP

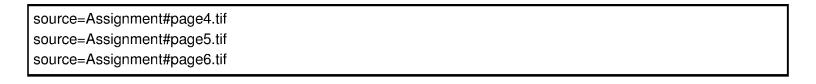
Address Line 2:701 FIFTH AVENUE, SUITE 5400Address Line 4:SEATTLE, WASHINGTON 98104

ATTORNEY DOCKET NUMBER:	860238.401D1
NAME OF SUBMITTER:	HAI HAN, PH.D.
SIGNATURE:	/Hai Han/
DATE SIGNED:	08/04/2020

Total Attachments: 6

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PATENT 506188015 REEL: 053401 FRAME: 0265



PATENT REEL: 053401 FRAME: 0266

ASSIGNMENT

WHEREAS, we.

Name	Address			
Dong Young WON	101-305, 33, Nambusunhwan-ro 365-gil, Gangnam-gu, Seoul, Republic of Korea	;		
Hyun Jai LIM	105-904, 20, Munseong-ro, Goa-eup, Gumi-si, ; and Gyeongsangbuk-do, Republic of Korea			
Kyung Su KIM	102, 85, Bangbaecheon-ro 2an-gil, Seocho-gu, Seoul, Republic of Korea	· ?		

(hereinafter referred to as ASSIGNORS), having mailing addresses as listed above, are the joint inventors of an invention entitled "GRAPHITE SHEET HAVING EXCELLENT THERMAL CONDUCTIVITY AND METHOD FOR PREPARING THE SAME," as described and claimed in the specification forming part of an application for United States letters patent executed herewith:

WHEREAS.

Name	Address	
SKCKOLON PI Inc.	27, Godeung 1-gil, Iwol-myeon, Jincheon-gun, Chungcheongbuk-do, Republic of Korea	

(hereinafter referred to as ASSIGNEE), residing at the address listed above, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions including any extensions or adjustments in term thereof and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, and including the right to sue and collect damages for past and present infringement of said letters patent; said invention, application and all letters patent on said invention to be held and

enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

Dec 20th, 2019	Fd 32 (Assignor)
Date	Dong Young WON
•	ve satisfactory evidence that Dong Young WON signed is a voluntary act for the uses and purposes mentioned in
Date Dec. 28, 2017	Signed at
Myyng Sik YU (Name of Witness)	(Signature of Witness)

Dec	27th, 2017	0/	行っ	η	(Assignor)
Date		Hyun Jai LIM		7	
instrument of instrument.	I certify that I know or ha his/her own free will, as a v	,		· ·	•
Date Dec	. 28,2017	Signed at	***************************************		17-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-
Myung (Name	Six YU	(Signature of V	k		

Dec 27th 2017	TAL	(Assignor)
Date	Kyung Su KIM	(
I certify that I know of instrument of his/her own free will, a instrument.	or have satisfactory evidence that F as a voluntary act for the uses and	
Date <u>Dec. 28, 2017</u>	Signed at	
Myung Sik YU (Name of Witness)	(Signature of Witness)	

Dec	, 27th,	2017
Date		

Signatory Signature)

(Assignee)

Tae Lim Eivn / CEO
(Assignee Signatory Name, Title)

Docket No. 869238 401] Assignment Unsigned